New Product

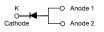


Vishay General Semiconductor

High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F = 0.34$ V at $I_F = 5$ A

TMBS[®] eSMP[®] Series K TO-277A (SMPC)



PRIMARY CHARACTERISTICS				
I _{F(AV)}	10 A			
V _{RRM}	45 V			
I _{FSM}	180 A			
V_F at $I_F = 10$ A	0.41 V			
T _J max.	150 °C			

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Base P/NH-M3 - halogen-free, RoHS compliant, and automotive grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V10P45	UNIT	
Device marking code		V1045		
Maximum repetitive peak reverse voltage	V _{RRM}	45	V	
Maximum DC forward current	I _F ⁽¹⁾	10	- A	
	I _F ⁽²⁾	4.4		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	180	А	
Operating junction and storage temperature range	T _J , T _{STG}	- 40 to + 150	°C	

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended copper pad area



FREE

V10P45



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 5.0 A	T _A = 25 °C	V _F (1)	0.42	-	- V
	I _F = 10 A			0.48	0.57	
	I _F = 5.0 A	– T _A = 125 °C		0.34	-	
	I _F = 10 A			0.41	0.50	
Reverse current	V _B = 45 V	T _A = 25 °C	I _R (2)	21	800	μA
		T _A = 125 °C		9	35	mA

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V10P45	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾	75	°C/W	
	R _{0JM} ⁽²⁾	4		

Notes

 $^{(1)}\,$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(2)}$ Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

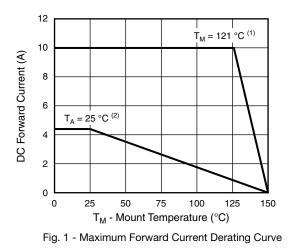
ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V10P45-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V10P45-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	
V10P45HM3/86A ⁽¹⁾	0.10	86A	1500	7" diameter plastic tape and reel	
V10P45HM3/87A ⁽¹⁾	0.10	87A	6500	13" diameter plastic tape and reel	

Note

⁽¹⁾ AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)



Notes

 $^{(1)}$ Mounted on 30 mm x 30 mm aluminum PCB; T_M measured at the terminal of cathode band (R_{0JM} = 4 $^\circ C/W)$

 $^{(2)}$ Free air, mounted on recommended copper pad area $(R_{\theta,JA}=75~^{\circ}C/W)$

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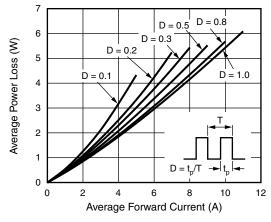


Fig. 2 - Forward Power Loss Characteristics

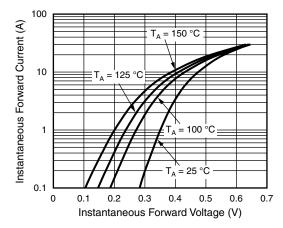


Fig. 3 - Typical Instantaneous Forward Characteristics

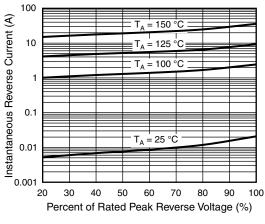


Fig. 4 - Typical Reverse Leakage Characteristics

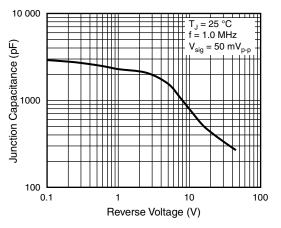


Fig. 5 - Typical Junction Capacitance

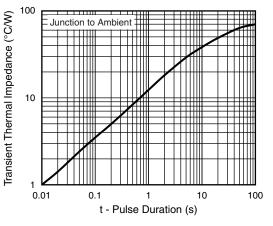
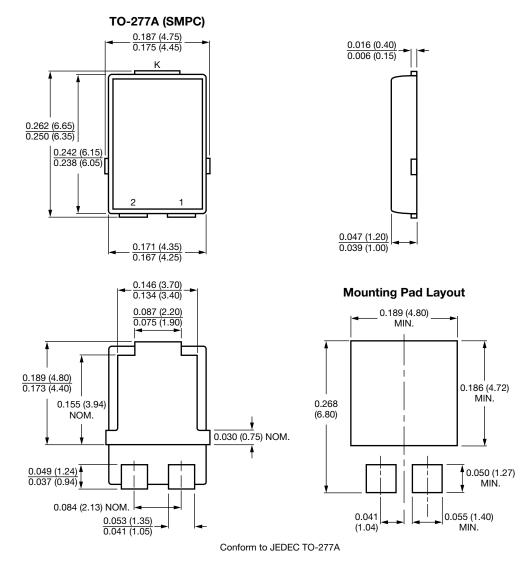


Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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